

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT5500287

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
TAI-YEN PENG	10/20/2017
HUI-HSIEN WEI	10/19/2017
WEI-CHIH WEN	10/20/2017
PIN-REN DAI	10/20/2017
CHIEN-MIN LEE	10/20/2017
HAN-TING TSAI	10/20/2017
JYU-HORNG SHIEH	10/20/2017
CHUNG-TE LIN	10/20/2017
RECEIVING PARTY DATA	
Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
Street Address:	NO.8, LI-HSIN RD.6
Internal Address:	SCIENCE-BASED INDUSTRIAL PARK
City:	HSINCHU
State/Country:	TAIWAN
Postal Code:	300
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16397871
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	4352521360
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Correspondent Name:	R. BURNS ISRAELSEN
Address Line 1:	MASCHOFF BRENNAN
Address Line 2:	1389 CENTER DR. SUITE 300
Address Line 4:	PARK CITY, UTAH 84098
ATTORNEY DOCKET NUMBER:	T1516.10389US02
NAME OF SUBMITTER:	R. BURNS ISRAELSEN

PATENT

SIGNATURE:	/R. Burns Israelsen, Reg. No. 42685/
DATE SIGNED:	04/30/2019
Total Attachments: 3 source=T1516-10389US02 Assignment#page1.tif source=T1516-10389US02 Assignment#page2.tif source=T1516-10389US02 Assignment#page3.tif	

ASSIGNMENT

This assignment agreement is applicable to an invention entitled (Invention Title) _____
MEMORY DEVICE AND FABRICATION METHOD THEREOF

The PATENT RIGHTS referred to in this agreement are:

(check one) a patent application for this invention, executed by the ASSIGNOR(S)
 concurrently with this assignment.

U.S. patent application Serial No. 16/397,871, filed April 29, 2019

a U.S. patent application based on PCT International Application

No. _____ filed on (date) _____ (U.S. patent application
 Serial No. _____, if known).

U.S. patent No. _____, issued _____.

The PATENT RIGHTS also include all divisions, reissues, continuations and extensions of
 the patents and patent applications identified above.

The PATENT RIGHTS assigned under this agreement are:

(check one) U.S. patent rights only.

Worldwide patent rights. In this case, the assignee shall have the right to
 claim the benefit of the filing date of any U.S. or foreign patent application
 for this invention.

The ASSIGNOR(S) referred to in this agreement is (or are) the inventor(s) whose signatures
 appear on page 2 of this Assignment and any Supplemental Sheet(s).

The ASSIGNEE referred to in this agreement is:

(Name of Assignee) TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.

(Address) NO.8, LI-HSIN RD.6, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU,
 TAIWAN 300, R.O.C.

The ASSIGNEE is:

(check one) An individual.

A Partnership.

A Corporation of TAIWAN, R.O.C. (specify state or country)

(other) _____

The ASSIGNOR(S), in consideration of \$10.00 paid by the ASSIGNEE, and other good and
 valuable consideration, receipt of which is acknowledged, hereby assign(s) the following
 rights to the ASSIGNEE, its successors and assigns:

the full and exclusive right to the invention;

the entire right, title and interest in and to the PATENT RIGHTS;

the right to sue and recover for any past infringement; and

the right to claim priority under 35 USC 119, 35 USC 120, or any other applicable
 provisions, based on any earlier patent applications for this invention.

THIS IS PAGE 2 OF AN ASSIGNMENT FROM THE INVENTOR(S) TO
 ASSIGNEE: TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.
 INVENTION TITLE: MEMORY DEVICE AND FABRICATION METHOD
THEREOF

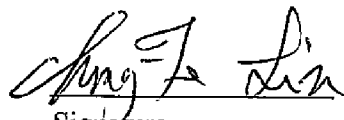
As to all U.S. patent applications assigned under this agreement, the ASSIGNOR(S) hereby authorize(s) and request(s) the Commissioner of Patents and Trademark to issue all Letters Patent to the ASSIGNEE as the assignee of the entire right, title and interest, for the sole use and enjoyment of said ASSIGNEE, its successors and assigns.

Further, the ASSIGNOR(S) agree(s) to communicate to said ASSIGNEE, or its representatives, any fact known to the ASSIGNOR(S) with respect to said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal, reexamination and reissue applications, execute all necessary assignment papers to cause and all Letter Patent to be issued to said ASSIGNEE, make all rightful oaths and generally do everything necessary or desirable to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention.

The ASSIGNOR(S) authorize(s) the attorneys and agents who have the power of attorney in this application to check any appropriate boxes and to insert the Serial Number and filing date in this document after it has been executed.

<u>Tai-Yen PENG</u> Name of sole or first inventor	<u>Tai-Yen Peng</u> Signature	<u>2017/10/20.</u> Date
<u>Hui-Hsien WEI</u> Name of second inventor, if any	<u>Hui-Hsien WEI</u> Signature	<u>2017/10/19</u> Date
<u>Wei-Chih WEN</u> Name of third inventor, if any	<u>Wei-Chih WEN</u> Signature	<u>2017/10/20</u> Date
<u>Pin-Ren DAI</u> Name of fourth inventor, if any	<u>Pin-Ren DAI</u> Signature	<u>2017/10/20.</u> Date
<u>Chien-Min LEE</u> Name of fifth inventor, if any	<u>Chien-Min Lee</u> Signature	<u>2017/10/20</u> Date
<u>Han-Ting TSAI</u> Name of sixth inventor, if any	<u>Han-Ting Tsai</u> Signature	<u>2017/10/20</u> Date
<u>Jyu-Horng SHIEH</u> Name of seventh inventor, if any	<u>Jyu-Horng Shieh</u> Signature	<u>2017/10/20</u> Date

Chung-Te LIN
Name of eighth inventor, if any


Signature

10/20/2019
Date